



REQUIREMENTS

Temperature:

- T_p for Lead-Free: 260-265°C
- T_p for Tin-Lead: 240-245°C
- T_p for Nickel-Paladium-Gold: 260-265°C

Preheat time and temperature depends on solder paste and flux activation temperature, component size, weight, surface area & plating.

Available Leadframes:

- Tin-Lead (Sn/Pb): 85/15
- Nickel-Paladium-Gold (Ni/Pd/Au): 94.5/3/2.5

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